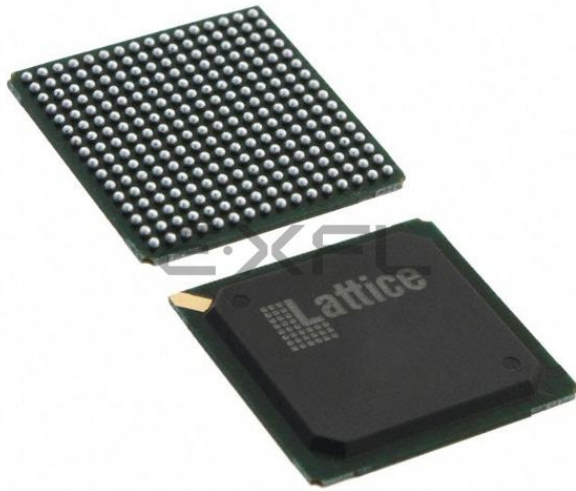




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	2375
Number of Logic Elements/Cells	19000
Total RAM Bits	1246208
Number of I/O	140
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m20e-5f256c

ROM Mode

ROM mode uses the LUT logic; hence, Slices 0 through 3 can be used in ROM mode. Preloading is accomplished through the programming interface during PFU configuration.

Routing

There are many resources provided in the LatticeECP2/M devices to route signals individually or as buses with related control signals. The routing resources consist of switching circuitry, buffers and metal interconnect (routing) segments.

The inter-PFU connections are made with x1 (spans two PFU), x2 (spans three PFU) and x6 (spans seven PFU). The x1 and x2 connections provide fast and efficient connections in horizontal and vertical directions. The x2 and x6 resources are buffered, allowing the routing of both short and long connections between PFUs.

The LatticeECP2/M family has an enhanced routing architecture that produces a compact design. The Diamond design software takes the output of the synthesis tool and places and routes the design. Generally, the place and route tool is completely automatic, although an interactive routing editor is available to optimize the design.

sysCLOCK Phase Locked Loops (GPLL/SPLL)

The sysCLOCK PLLs provide the ability to synthesize clock frequencies. All the devices in the LatticeECP2/M family support two General Purpose PLLs (GPLLs) which are full-featured PLLs. In addition, some of the larger devices have two to six Standard PLLs (SPLLs) that have a subset of GPLL functionality.

General Purpose PLL (GPLL)

The architecture of the GPLL is shown in Figure 2-5. A description of the GPLL functionality follows.

CLKI is the reference frequency (generated either from the pin or from routing) for the PLL. CLKI feeds into the Input Clock Divider block. The CLKFB is the feedback signal (generated from CLKOP or from a user clock PIN/logic). This signal feeds into the Feedback Divider. The Feedback Divider is used to multiply the reference frequency.

The Delay Adjust Block adjusts either the delays of the reference or feedback signals. The Delay Adjust Block can either be programmed during configuration or can be adjusted dynamically. The setup, hold or clock-to-out times of the device can be improved by programming a delay in the feedback or input path of the PLL, which will advance or delay the output clock with reference to the input clock.

Following the Delay Adjust Block, both the input path and feedback signals enter the Voltage Controlled Oscillator (VCO) block. In this block the difference between the input path and feedback signals is used to control the frequency and phase of the oscillator. A LOCK signal is generated by the VCO to indicate that the VCO has locked onto the input clock signal. In dynamic mode, the PLL may lose lock after a dynamic delay adjustment and not relock until the t_{LOCK} parameter has been satisfied. LatticeECP2/M devices have two dedicated pins on the left and right edges of the device for connecting optional external capacitors to the VCO. This allows the PLLs to operate at a lower frequency. This is a shared resource that can only be used by one PLL (GPLL or SPLL) per side.

The output of the VCO then enters the post-scalar divider. The post-scalar divider allows the VCO to operate at higher frequencies than the clock output (CLKOP), thereby increasing the frequency range. A secondary divider takes the CLKOP signal and uses it to derive lower frequency outputs (CLKOK). The Phase/Duty Select block adjusts the phase and duty cycle of the CLKOP signal and generates the CLKOS signal. The phase/duty cycle setting can be pre-programmed or dynamically adjusted.

The primary output from the post scalar divider CLKOP along with the outputs from the secondary divider (CLKOK) and Phase/Duty select (CLKOS) are fed to the clock distribution network.

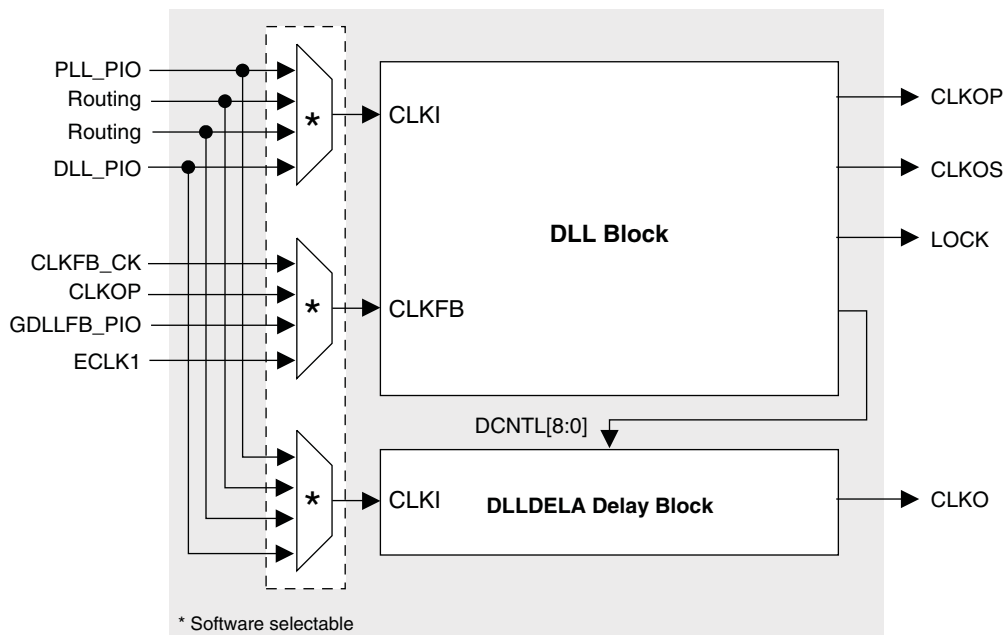
Table 2-5. DLL Signals

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	DLL feed input from DLL output, clock net, routing or external pin
RSTN	I	Active low synchronous reset
ALUHOLD	I	Active high freezes the ALU
UDDCNTL	I	Synchronous enable signal (hold high for two cycles) from routing
DCNTL[8:0]	O	Encoded digital control signals for PIC INDEL and slave delay calibration
CLKOP	O	The primary clock output
CLKOS	O	The secondary clock output with fine phase shift and/or division by 2 or by 4
LOCK	O	Active high phase lock indicator

DLLDELA Delay Block

Closely associated with each DLL is a DLLDELA block. This is a delay block consisting of a delay line with taps and a selection scheme that selects one of the taps. The DCNTL[8:0] bus controls the delay of the CLKO signal. Typically this is the delay setting that the DLL uses to achieve phase alignment. This results in the delay providing a calibrated 90° phase shift that is useful in centering a clock in the middle of a data cycle for source synchronous data. The CLKO signal feeds the edge clock network. Figure 2-7 shows the connections between the DLL block and the DLLDELA delay block. For more information, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-7. DLLDELA Delay Block

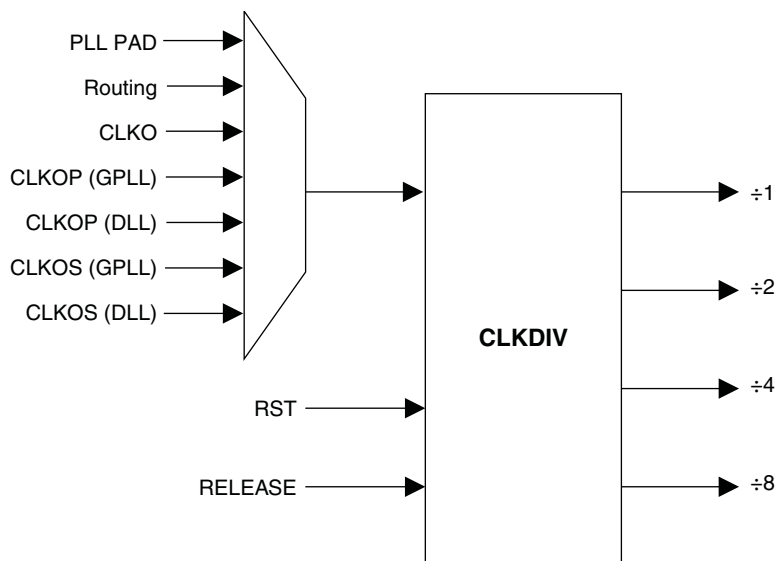


PLL/DLL Cascading

LatticeECP2/M devices have been designed to allow certain combinations of PLL (GPLL and SPLL) and DLL cascading. The allowable combinations are:

- PLL to PLL supported
- PLL to DLL supported

Figure 2-9. Clock Divider Connections



Clock Distribution Network

LatticeECP2/M devices have eight quadrant-based primary clocks and eight flexible region-based secondary clocks/control signals. Two high performance edge clocks are available on each edge of the device to support high speed interfaces. These clock inputs are selected from external I/Os, the sysCLOCK PLLs, DLLs or routing. These clock inputs are fed throughout the chip via a clock distribution system.

Primary Clock Sources

LatticeECP2/M devices derive clocks from five primary sources: PLL (GPLL and SPLL) outputs, DLL outputs, CLK-DIV outputs, dedicated clock inputs and routing. LatticeECP2/M devices have two to eight sysCLOCK PLLs and two DLLs, located on the left and right sides of the device. There are eight dedicated clock inputs, two on each side of the device, with the exception of the LatticeECP2M 256-fpBGA package devices which have six dedicated clock inputs on the device. Figure 2-10 shows the primary clock sources.

LatticeECP2M Supply Current (Standby)^{1, 2, 3, 4}
Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	ECP2M20	25	mA
		ECP2M35	50	mA
		ECP2M50	85	mA
		ECP2M70	100	mA
		ECP2M100	100	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2M20	24	mA
		ECP2M35	24	mA
		ECP2M50	24	mA
		ECP2M70	24	mA
		ECP2M100	24	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	All Devices	0.5	mA
I_{CCSPLL}	GPLL Power Supply Current (per SPLL)	All Devices	0.5	mA
I_{CCIO}	Bank Power Supply Current (Per Bank)	ECP2M20	2	mA
		ECP2M35	2	mA
		ECP2M50	2	mA
		ECP2M70	2	mA
		ECP2M100	2	mA
I_{CCJ}	V_{CCJ} Power Supply Current	All Devices	3	mA

1. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.

2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.

3. Frequency 0MHz.

4. Pattern represents a "blank" configuration data file.

5. $T_J = 25^{\circ}\text{C}$, power supplies at normal voltage.

LatticeECP2M Power Supply and NC

Signal	256 fpBGA	484 fpBGA
V _{CC}	G7, G9, H7, J10, K10, K8	J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13
V _{CCIO0}	E7	B5, B9, E7, H9
V _{CCIO1}	E10	D13, E16, H14
V _{CCIO2}	E14, G12	E21, G18, J15, K19
V _{CCIO3}	K12, M14	N19, P15, T18, V21
V _{CCIO4}	M10, P12	AA18, R14, V16, W13
V _{CCIO5}	M7, P5	AA5, R9, V7, W10
V _{CCIO6}	K5, M3	N4, P8, T5, V2
V _{CCIO7}	E3, G5	E2, G5, J8, K4
V _{CCIO8}	T15	AA22, U19
V _{CCJ}	K7	W4
V _{CCAUX}	G8, H10, J7, K9	H11, H12, L15, L8, M15, M8, R11, R12
V _{CCPLL}	G10	R8, H15, H8, R15
SERDES Power ³	C15, B15, C12, A12, C11, C10, C14, C13, B9, C9, C5, C4, C8, C7, A6, C6, B3, C3	C22, B22, C19, A19, C18, C17, C21, C20, B16, C16, C12, C11, C15, C14, A13, C13, B10, C10
GND ¹	A1, A15, A16, A3, A9, B12, B6, E15, E2, H14, H8, H9, J3, J8, J9, M15, M2, P9, R12, R5, T1, T16	A1, A10, A16, A22, AA19, AA4, AB1, AB22, B13, B19, B4, D16, D2, D21, D7, G19, G4, H10, H13, J14, J9, K10, K11, K12, K13, K15, K20, K3, K8, L10, L11, L12, L13, M10, M11, M12, M13, N10, N11, N12, N13, N15, N20, N3, N8, P14, P9, R10, R13, T19, T4, W16, W2, W21, W7, Y10, Y13
NC ²	D10, D11, D12, D13, D14, D4, D5, D6, D7, E11, E6, E8, E9, F10, F7, F8, F9	LFE2M20: D14, D15, E14, E15, F13, F14, F15, G12, G13, G14, G15 LFE2M35: D14, D15, E14, E15, F13, F14, F15, G12, G13, G14, G15, U6 LFE2M50: Y15, W15, AB20, AB21, AA20, AB19, AB18, Y22, Y21, Y17, Y18, Y16, W17, Y19, Y20, W19, W18, V17, V18, D15, G14, G15, D14, E15, E14, F15, F14, F13, G12, G13

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. For package migration across device densities, the designer must comprehend the package pin requirements for the SERDES blocks. Specifically, the SERDES power pins of the largest density device must be accounted to accommodate migration to other smaller devices using the same package. Please refer to TN1160, [LatticeECP2/M Density Migration](#) for more details.

LatticeECP2M Power Supply and NC (Cont.)

Signal	672 fpBGA	900 fpBGA
GND ¹	A13, A19, A2, A25, AA2, AA25, AB18, AB22, AB5, AB9, AE1, AE11, AE16, AE22, AE26, AE6, AF13, AF19, AF2, AF25, B1, B11, B16, B22, B26, B6, E18, E22, E5, E9, F2, F25, G11, G16, J22, J5, K11, K13, K14, K16, L10, L11, L16, L17, L2, L20, L25, L7, M13, M14, N10, N12, N13, N14, N15, N17, P10, P12, P13, P14, P15, P17, R13, R14, T10, T11, T16, T17, T2, T20, T25, T7, U11, U13, U14, U16, V22, V5, Y11, Y16	LFE2M50: A1, A13, A18, A24, A30, A7, AA14, AA15, AA16, AA17, AA24, AA27, AA4, AB24, AB7, AD12, AD19, AD27, AE22, AE27, AE4, AE9, AF14, AF17, AF25, AF6, AJ10, AJ21, AJ27, AJ4, AK1, AK13, AK18, AK24, AK30, AK7, B10, B21, B27, B4, D25, D6, E14, E17, F22, F27, F4, F9, G12, G19, J24, J7, K14, K15, K16, K17, K27, K4, L14, L15, L16, L17, M23, M8, N14, N15, N16, N17, N27, N4, P11, P13, P14, P15, P16, P17, P18, P20, R10, R11, R13, R14, R15, R16, R17, R18, R20, R21, R24, R7, T10, T11, T13, T14, T15, T16, T17, T18, T20, T21, T24, T7, U11, U13, U14, U15, U16, U17, U18, U20, V14, V15, V16, V17, V27, V4, W23, W8, Y14, Y15, Y16, Y17 LFE2M70/LFE2M100: A1, A13, A18, A24, A30, A7, AA14, AA15, AA16, AA17, AA24, AA27, AA4, AB24, AB7, AD12, AD19, AD27, AE22, AE27, AE4, AE9, AF14, AF17, AF25, AF6, AJ10, AJ21, AJ27, AJ4, AK1, AK13, AK18, AK24, AK30, AK7, B10, B21, B27, B4, D25, D6, E14, E17, F22, F27, F4, F9, G12, G19, J24, J7, K14, K15, K16, K17, K27, K4, L14, L15, L16, L17, M23, M8, N14, N15, N16, N17, N27, N4, P11, P13, P14, P15, P16, P17, P18, P20, R10, R11, R13, R14, R15, R16, R17, R18, R20, R21, R24, R7, T10, T11, T13, T14, T15, T16, T17, T18, T20, T21, T24, T7, U11, U13, U14, U15, U16, U17, U18, U20, V14, V15, V16, V17, V27, V4, W23, W8, Y14, Y15, Y16, Y17
NC ²	LFE2M35: AB3, AB4, AC1, AC2, AD15, AD18, AD20, AD23, AE13, AE25, AF16, AF22, B4, B5, C26, D20, D21, D22, D23, D24, D25, D26, E20, E21, E25, E26, F20, G20, K10, K17, R4, U10, U23, V10, W7, N7, V7 LFE2M50: AB3, AB4, AC1, AC2, B4, B5, C26, D20, D21, D22, D23, D24, D25, D26, E20, E21, E25, E26, F20, G20, K10, K17, R4, U10, U23, V10, W7, AB21, AC20, AC21, AC22, AC23, AC25, AD26, W20	LFE2M50: G5, G4, K7, K8, E1, F2, F1, G3, G2, G1, L9, L7, K6, K5, L8, L6, AA1, AA2, Y3, AB1, Y9, Y8, Y7, AA7, AB2, AB3, AA5, AA6, AB4, AB5, AA8, AA9, AJ1, AK4, AH6, AH3, AH11, AH8, AK10, AJ13, AB26, AB27, Y24, Y25, AA29, Y28, Y30, Y29, W22, V22, Y27, Y26, W30, W29, W25, W26, L24, L23, D30, D29, K24, K25, J27, K26, J26, H26, H27, G26, H23, H24, D28, E28, J18, J19, H17, J17, F18, F17, B13, A10, C8, C11, C3, C6, A4, B1, AA26, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AB19, AB20, AB21, AC11, AC21, AC22, AD21, AD22, AE23, AF20, AF23, AG23, AG26, F20, F23, G10, G20, G21, H19, H20, H21, H22, J20, J21, R9, U22, W9 LFE2M70/LFE2M100: AA26, AB10, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AB19, AB20, AB21, AB9, AC10, AC11, AC21, AC22, AC8, AC9, AD21, AD22, AD4, AD5, AD6, AD7, AD8, AE23, AE5, AE6, AE7, AF20, AF23, AF5, AG23, AG26, D10, E10, E11, F10, F20, F23, F8, G10, G20, G21, G7, G8, G9, H19, H20, H21, H22, H6, H8, H9, J10, J20, J21, J9, K9, R9, U22, W9

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. For package migration across device densities, the designer must comprehend the package pin requirements for the SERDES blocks. Specifically, the SERDES power pins of the largest density device must be accounted to accommodate migration to other smaller devices using the same package. Please refer to TN1160, [LatticeECP2/M Density Migration](#) for more details.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
91	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	
92	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	
93	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
94	VCC	-			VCC	-			
95	GND	-			GND	-			
96	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	
97	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	
98	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C	
99	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T	
100	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*	
101	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*	
102	VCC	-			VCC	-			
103	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C	
104	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T	
105	GND	-			GND	-			
106	VCCIO2	2			VCCIO2	2			
107	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*	
108	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*	
109	PT28B	1	VREF2_1	C	PT55B	1	VREF2_1	C	
110	PT28A	1	VREF1_1	T	PT55A	1	VREF1_1	T	
111	PT26B	1		C	PT54B	1		C	
112	PT26A	1		T	PT54A	1		T	
113	PT24B	1		C	PT52B	1		C	
114	PT24A	1		T	PT52A	1		T	
115	PT22B	1		C	PT50B	1		C	
116	PT22A	1		T	PT50A	1		T	
117	VCCIO1	1			VCCIO1	1			
118	PT20B	1		C	PT48B	1		C	
119	PT20A	1		T	PT48A	1		T	
120	GND	-			GND	-			
121	PT18B	1		C	PT44B	1		C	
122	PT18A	1		T	PT44A	1		T	
123	PT16A	1			PT40B	1		C	
124	NC	1			PT40A	1		T	
125	PT14B	1		C	PT34B	1		C	
126	PT14A	1		T	PT34A	1		T	
127	NC	1			NC	1			
128	VCC	-			VCC	-			
129	PT12B	1	PCLKC1_0	C	PT30B	1	PCLKC1_0	C	
130	PT12A	1	PCLKT1_0	T	PT30A	1	PCLKT1_0	T	
131	PT10B	0	PCLKC0_0	C	PT28B	0	PCLKC0_0	C	
132	XRES	0			XRES	0			
133	GND	-			GND	-			
134	PT10A	0	PCLKT0_0	T	PT28A	0	PCLKT0_0	T	
135	VCC	-			VCC	-			

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E4	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*
E5	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*
-	-	-			GNDIO7	-		
E3	NC	-			PL4A	7	LDQ8	T (LVDS)*
F4	PL3A	7		T	PL5A	7	LDQ8	T
F3	NC	-			PL4B	7	LDQ8	C (LVDS)*
F5	PL3B	7		C	PL5B	7	LDQ8	C
VCCIO	VCCIO7	7			VCCIO7	7		
E2	PL4A	7		T (LVDS)*	PL6A	7	LDQ8	T (LVDS)*
G6	PL5A	7		T	PL7A	7	LDQ8	T
E1	PL4B	7		C (LVDS)*	PL6B	7	LDQ8	C (LVDS)*
G7	PL5B	7		C	PL7B	7	LDQ8	C
GNDIO	GNDIO7	-			GNDIO7	-		
F1	NC	-			PL9A	7	LDQ8	T
H4	NC	-			PL8A	7	LDQS8	T (LVDS)*
F2	NC	-			PL9B	7	LDQ8	C
-	-	-			VCCIO7	7		
H5	NC	-			PL8B	7	LDQ8	C (LVDS)*
G1	NC	-			PL11A	7	LDQ8	T
G3	NC	-			PL10A	7	LDQ8	T (LVDS)*
G2	NC	-			PL11B	7	LDQ8	C
-	-	-			GNDIO	-		
G4	NC	-			PL10B	7	LDQ8	C (LVDS)*
J4	PL7A	7	LDQ10	T	PL13A	7	LDQ16	T
H1	PL6A	7	LDQ10		PL12A	7	LDQ16	T (LVDS)*
J5	PL7B	7	LDQ10	C	PL13B	7	LDQ16	C
L6	PL9A	7	LDQ10	T	PL15A	7	LDQ16	T
VCCIO	VCCIO7	7			VCCIO7	7		
J2	PL8A	7	LDQ10	T (LVDS)*	PL14A	7	LDQ16	T (LVDS)*
L5	PL9B	7	LDQ10	C	PL15B	7	LDQ16	C
J1	PL8B	7	LDQ10	C (LVDS)*	PL14B	7	LDQ16	C (LVDS)*
K3	PL10A	7	LDQS10	T (LVDS)*	PL16A	7	LDQS16	T (LVDS)*
GNDIO	GNDIO7	-			GNDIO	-		
K4	PL10B	7	LDQ10	C (LVDS)*	PL16B	7	LDQ16	C (LVDS)*
K2	PL11A	7	LDQ10	T	PL17A	7	LDQ16	T
VCCIO	VCCIO7	7			VCCIO7	7		
K1	PL11B	7	LDQ10	C	PL17B	7	LDQ16	C
L4	PL12A	7	LDQ10	T (LVDS)*	PL18A	7	LDQ16	T (LVDS)*
GNDIO	GNDIO7	-			GNDIO	-		
L3	PL12B	7	LDQ10	C (LVDS)*	PL18B	7	LDQ16	C (LVDS)*
L2	PL13A	7	PCLKT7_0/LDQ10	T	PL19A	7	PCLKT7_0/LDQ16	T
L1	PL13B	7	PCLKC7_0/LDQ10	C	PL19B	7	PCLKC7_0/LDQ16	C
M5	PL15A	6	PCLKT6_0	T (LVDS)*	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*
VCCIO	VCCIO6	6			-	-		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
U24	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*	PR44B	3	RLM0_GPLL_C_IN_A**/RDQ48	C (LVDS)*	
U25	PR30A	3	RLM0_GPLL_T_IN_A**/RDQ34	T (LVDS)*	PR44A	3	RLM0_GPLL_T_IN_A**/RDQ48	T (LVDS)*	
R20	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
P18	VCC	3			VCCPLL	3			
T19	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C	PR42B	3	RLM0_GDLLC_FB_A/RDQ39	C	
U20	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T	PR42A	3	RLM0_GDLLT_FB_A/RDQ39	T	
GND	GNDIO3	-			GNDIO3	-			
T25	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*	PR41B	3	RLM0_GDLLC_IN_A**/RDQ39	C (LVDS)*	
T26	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*	PR41A	3	RLM0_GDLLT_IN_A**/RDQ39	T (LVDS)*	
T20	PR26B	3	RDQ25	C	PR40B	3	RDQ39	C	
T22	PR26A	3	RDQ25	T	PR40A	3	RDQ39	T	
VCCIO	VCCIO3	3			VCCIO3	3			
R26	PR25B	3	RDQ25	C (LVDS)*	PR39B	3	RDQ39	C (LVDS)*	
R25	PR25A	3	RDQS25***	T (LVDS)*	PR39A	3	RDQS39***	T (LVDS)*	
R22	NC	-			PR38B	3	RDQ39	C	
GND	GNDIO3	-			GNDIO3	-			
T21	NC	-			PR38A	3	RDQ39	T	
P26	NC	-			NC	-			
P25	NC	-			NC	-			
R24	NC	-			NC	-			
VCCIO	VCCIO3	3			VCCIO3	3			
R23	NC	-			NC	-			
P20	NC	-			NC	-			
R19	NC	-			NC	-			
P21	NC	-			PR34B	3	RDQ31	C	
GND	GNDIO3	-			GNDIO3	-			
P19	NC	-			PR34A	3	RDQ31	T	
P23	NC	-			PR33B	3	RDQ31	C (LVDS)*	
P22	NC	-			PR33A	3	RDQ31	T (LVDS)*	
N22	NC	-			PR32B	3	RDQ31	C	
VCCIO	VCCIO3	3			VCCIO3	3			
R21	NC	-			PR32A	3	RDQ31	T	
N26	NC	-			PR31B	3	RDQ31	C (LVDS)*	
N25	NC	-			PR31A	3	RDQS31	T (LVDS)*	
GND	GNDIO3	-			GNDIO3	-			
N19	PR24B	3	RDQ25	C	PR30B	3	RDQ31	C	
N20	PR24A	3	RDQ25	T	PR30A	3	RDQ31	T	
M26	PR23B	3	RDQ25	C (LVDS)*	PR29B	3	RDQ31	C (LVDS)*	
M25	PR23A	3	RDQ25	T (LVDS)*	PR29A	3	RDQ31	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
N18	PR22B	3	VREF2_3/RDQ25	C	PR28B	3	VREF2_3/RDQ31	C	
N21	PR22A	3	VREF1_3/RDQ25	T	PR28A	3	VREF1_3/RDQ31	T	
L26	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*	PR27B	3	PCLKC3_0/RDQ31	C (LVDS)*	
L25	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*	PR27A	3	PCLKT3_0/RDQ31	T (LVDS)*	
N24	PR19B	2	PCLKC2_0/RDQ16	C	PR25B	2	PCLKC2_0/RDQ22	C	
M23	PR19A	2	PCLKT2_0/RDQ16	T	PR25A	2	PCLKT2_0/RDQ22	T	

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A2	GND	-			GND	-		
A25	GND	-			GND	-		
AA18	GND	-			GND	-		
AA24	GND	-			GND	-		
AA3	GND	-			GND	-		
AA9	GND	-			GND	-		
AD11	GND	-			GND	-		
AD16	GND	-			GND	-		
AD21	GND	-			GND	-		
AD6	GND	-			GND	-		
AE1	GND	-			GND	-		
AE26	GND	-			GND	-		
AF2	GND	-			GND	-		
AF25	GND	-			GND	-		
B1	GND	-			GND	-		
B26	GND	-			GND	-		
C11	GND	-			GND	-		
C16	GND	-			GND	-		
C21	GND	-			GND	-		
C6	GND	-			GND	-		
F18	GND	-			GND	-		
F24	GND	-			GND	-		
F3	GND	-			GND	-		
F9	GND	-			GND	-		
J13	GND	-			GND	-		
J14	GND	-			GND	-		
J21	GND	-			GND	-		
J6	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K13	GND	-			GND	-		
K14	GND	-			GND	-		
K16	GND	-			GND	-		
K17	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		
L16	GND	-			GND	-		
L17	GND	-			GND	-		
L24	GND	-			GND	-		
L3	GND	-			GND	-		
M13	GND	-			GND	-		
M14	GND	-			GND	-		
N10	GND	-			GND	-		
N12	GND	-			GND	-		
N13	GND	-			GND	-		
N14	GND	-			GND	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AG4	NC	-		
AG8	NC	-		
AH1	NC	-		
AH16	NC	-		
AH2	NC	-		
AH26	NC	-		
AH27	NC	-		
AH29	NC	-		
AH30	NC	-		
AH4	NC	-		
AJ1	NC	-		
AJ2	NC	-		
AJ27	NC	-		
AJ28	NC	-		
AJ29	NC	-		
AJ3	NC	-		
AJ30	NC	-		
AK2	NC	-		
AK27	NC	-		
AK28	NC	-		
AK29	NC	-		
AK3	NC	-		
B1	NC	-		
B2	NC	-		
B3	NC	-		
B30	NC	-		
B4	NC	-		
B5	NC	-		
C1	NC	-		
C2	NC	-		
C29	NC	-		
C30	NC	-		
C4	NC	-		
D13	NC	-		
D18	NC	-		
D23	NC	-		
D28	NC	-		
D29	NC	-		
D3	NC	-		
D30	NC	-		
D4	NC	-		
E25	NC	-		
E26	NC	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
E27	NC	-		
E28	NC	-		
E29	NC	-		
E3	NC	-		
E30	NC	-		
E4	NC	-		
E5	NC	-		
E6	NC	-		
F25	NC	-		
F5	NC	-		
F6	NC	-		
G6	NC	-		
G7	NC	-		
K10	NC	-		
K9	NC	-		
N27	NC	-		
N4	NC	-		
R1	NC	-		
R2	NC	-		
V27	NC	-		
V4	NC	-		
P22	VCCPLL	-		
P8	VCCPLL	-		
T22	VCCPLL	-		
Y7	VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
G5	VCCIO7	7		
J8	VCCIO7	7		
K4	VCCIO7	7		
AA22	VCCIO8	8		
U19	VCCIO8	8		
H11	VCCAUX	-		
H12	VCCAUX	-		
L15	VCCAUX	-		
L8	VCCAUX	-		
M15	VCCAUX	-		
M8	VCCAUX	-		
R11	VCCAUX	-		
R12	VCCAUX	-		
A1	GND	-		
A10	GND	-		
A16	GND	-		
A22	GND	-		
AA19	GND	-		
AA4	GND	-		
AB1	GND	-		
AB22	GND	-		
B13	GND	-		
B19	GND	-		
B4	GND	-		
D16	GND	-		
D2	GND	-		
D21	GND	-		
D7	GND	-		
G19	GND	-		
G4	GND	-		
H10	GND	-		
H13	GND	-		
J14	GND	-		
J9	GND	-		
K10	GND	-		
K11	GND	-		
K12	GND	-		
K13	GND	-		
K15	GND	-		
K20	GND	-		
K3	GND	-		
K8	GND	-		
L10	GND	-		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AH12	VCC	-			LLC_SQ_VCCR1	14			
AK8	PB16A	5	BDQ15	T	LLC_SQ_HDOUTP1	14		T	
AH8	NC	-			LLC_SQ_VCCOB1	14			
AJ8	PB16B	5	BDQ15	C	LLC_SQ_HDOUTN1	14		C	
AH9	VCC	-			LLC_SQ_VCCTX1	14			
AJ9	PB17B	5	BDQ15	C	LLC_SQ_HDOUTN0	14		C	
AK10	NC	-			LLC_SQ_VCCOB0	14			
AK9	PB17A	5	BDQ15	T	LLC_SQ_HDOUTP0	14		T	
AH10	VCC	-			LLC_SQ_VCCTX0	14			
AJ12	PB19B	5	BDQ15	C	LLC_SQ_HDINN0	14		C	
AJ13	NC	-			LLC_SQ_VCCIB0	14			
AK12	PB19A	5	BDQ15	T	LLC_SQ_HDINP0	14		T	
AH13	VCC	-			LLC_SQ_VCCR0	14			
AF10	PB3A	5	BDQ6	T	PB30A	5	BDQ33	T	
AE8	PB3B	5	BDQ6	C	PB30B	5	BDQ33	C	
AE11	PB4A	5	BDQ6	T	PB31A	5	BDQ33	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AD9	PB4B	5	BDQ6	C	PB31B	5	BDQ33	C	
AE10	PB5A	5	BDQ6	T	PB32A	5	BDQ33	T	
AD10	PB5B	5	BDQ6	C	PB32B	5	BDQ33	C	
AE13	PB6A	5	BDQS6	T	PB33A	5	BDQS33	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AC12	PB6B	5	BDQ6	C	PB33B	5	BDQ33	C	
AG2	PB7A	5	BDQ6	T	PB34A	5	BDQ33	T	
AG3	PB7B	5	BDQ6	C	PB34B	5	BDQ33	C	
AD13	PB8A	5	BDQ6	T	PB35A	5	BDQ33	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AC13	PB8B	5	BDQ6	C	PB35B	5	BDQ33	C	
AE14	PB9A	5	BDQ6	T	PB36A	5	BDQ33	T	
AC14	PB9B	5	BDQ6	C	PB36B	5	BDQ33	C	
AF3	PB10A	5	BDQ6	T	PB37A	5	BDQ33	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AF4	PB10B	5	BDQ6	C	PB37B	5	BDQ33	C	
VCCIO	VCCIO5	5			-	-			
AG4	PB20A	5	BDQ24	T	PB38A	5	BDQ42	T	
AG5	PB20B	5	BDQ24	C	PB38B	5	BDQ42	C	
GNDIO	GNDIO5	-			-	-			
VCCIO	VCCIO5	5			-	-			
AD11	PB24A	5	BDQS24****	T	PB39A	5	BDQ42	T	
AF13	PB24B	5	BDQ24	C	PB39B	5	BDQ42	C	
AF12	PB25A	5	BDQ24	T	PB40A	5	BDQ42	T	
-	-	-			VCCIO5	5			
AD14	PB25B	5	BDQ24	C	PB40B	5	BDQ42	C	
AG8	PB26A	5	BDQ24	T	PB41A	5	BDQ42	T	
AF8	PB26B	5	BDQ24	C	PB41B	5	BDQ42	C	
AE15	PB27A	5	BDQ24	T	PB42A	5	BDQS42****	T	
-	-	-			GNDIO5	-			
VCCIO	VCCIO5	5			-	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AH25	LRC_SQ_VCCOB1	13			LRC_SQ_VCCOB1	13			
AJ25	LRC_SQ_HDOUTN1	13		C	LRC_SQ_HDOUTN1	13		C	
AH26	LRC_SQ_VCCTX1	13			LRC_SQ_VCCTX1	13			
AJ26	LRC_SQ_HDOUTN0	13		C	LRC_SQ_HDOUTN0	13		C	
AK27	LRC_SQ_VCCOB0	13			LRC_SQ_VCCOB0	13			
AK26	LRC_SQ_HDOUTP0	13		T	LRC_SQ_HDOUTP0	13		T	
AH27	LRC_SQ_VCCTX0	13			LRC_SQ_VCCTX0	13			
AJ29	LRC_SQ_HDINN0	13		C	LRC_SQ_HDINN0	13		C	
AJ30	LRC_SQ_VCCIB0	13			LRC_SQ_VCCIB0	13			
AK29	LRC_SQ_HDINP0	13		T	LRC_SQ_HDINP0	13		T	
AH30	LRC_SQ_VCCRX0	13			LRC_SQ_VCCRX0	13			
AG27	CFG2	8			CFG2	8			
AD25	CFG1	8			CFG1	8			
AG28	CFG0	8			CFG0	8			
AG30	PROGRAMN	8			PROGRAMN	8			
AG29	CCLK	8			CCLK	8			
AC24	INITN	8			INITN	8			
AF27	DONE	8			DONE	8			
GNDIO	GNDIO8	-			GNDIO8	-			
AF28	WRITEN***	8			WRITEN***	8			
AE26	CS1N***	8			CS1N***	8			
AB23	CSN***	8			CSN***	8			
AF29	D0/SPIFASTN***	8			D0/SPIFASTN***	8			
VCCIO	VCCIO8	8			VCCIO8	8			
AF30	D1***	8			D1***	8			
AD26	D2***	8			D2***	8			
AE29	D3***	8			D3***	8			
GNDIO	GNDIO8	-			GNDIO8	-			
AE30	D4***	8			D4***	8			
AD29	D5***	8			D5***	8			
AC25	D6***	8			D6***	8			
AD30	D7/SPID0***	8			D7/SPID0***	8			
VCCIO	VCCIO8	8			VCCIO8	8			
AA22	DI/CSSPI0N***	8			DI/CSSPI0N***	8			
AC26	DOUT/CSON/ CSSPI1N***	8			DOUT/CSON/ CSSPI1N***	8			
AA23	BUSY/SISPI***	8			BUSY/SISPI***	8			
AB22	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
AC27	PR65B	3	RLM0_GDLLC_FB_A	C	PR85B	3	RLM0_GDLLC_FB_A/RDQ82	C	
GNDIO	GNDIO3	-			GNDIO3	-			
AC28	PR65A	3	RLM0_GDLLT_FB_A	T	PR85A	3	RLM0_GDLLT_FB_A/RDQ82	T	
AC29	PR64B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR84B	3	RLM0_GDLLC_IN_A**/RDQ82	C (LVDS)*	
AC30	PR64A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR84A	3	RLM0_GDLLT_IN_A**/RDQ82	T (LVDS)*	
AB30	PR63B	3	RLM0_GPLL_C_IN_A**	C	PR83B	3	RLM0_GPLL_C_IN_A**/RDQ82	C	
VCCIO	VCCIO3	3			VCCIO3	3			
AA30	PR63A	3	RLM0_GPLLT_IN_A**	T	PR83A	3	RLM0_GPLLT_IN_A**/RDQ82	T	
AB29	PR62B	3	RLM0_GPLL_C_FB_A	C (LVDS)*	PR82B	3	RLM0_GPLL_C_FB_A/RDQ82	C (LVDS)*	
AB28	PR62A	3	RLM0_GPLLT_FB_A	T (LVDS)*	PR82A	3	RLM0_GPLLT_FB_A/RDQ82	T (LVDS)*	
GNDIO	GNDIO3	-			GNDIO3	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
J2	PL34B	7	LDQ32	C (LVDS)*
H1	PL35A	7	LDQ32	T
GNDIO	GNDIO7	-		
J1	PL35B	7	LDQ32	C
GNDIO	GNDIO7	-		
L5	PL41A	7	LDQ45	T (LVDS)*
L4	PL41B	7	LDQ45	C (LVDS)*
N9	PL42A	7	LDQ45	T
N7	PL42B	7	LDQ45	C
K2	PL43A	7	LDQ45	T (LVDS)*
K1	PL43B	7	LDQ45	C (LVDS)*
P9	PL44A	7	LDQ45	T
P7	PL44B	7	LDQ45	C
GNDIO	GNDIO7	-		
M6	PL45A	7	LDQS45	T (LVDS)*
M5	PL45B	7	LDQ45	C (LVDS)*
N5	PL46A	7	LDQ45	T
N6	PL46B	7	LDQ45	C
M4	PL47A	7	LDQ45	T (LVDS)*
M3	PL47B	7	LDQ45	C (LVDS)*
P6	PL48A	7	LDQ45	T
GNDIO	GNDIO7	-		
P8	PL48B	7	LDQ45	C
L3	PL50A	7	LUM3_SPLLT_IN_A/LDQ54	T (LVDS)*
L2	PL50B	7	LUM3_SPLLC_IN_A/LDQ54	C (LVDS)*
P5	PL51A	7	LUM3_SPLLT_FB_A/LDQ54	T
P4	PL51B	7	LUM3_SPLLC_FB_A/LDQ54	C
L1	PL52A	7	LDQ54	T (LVDS)*
M2	PL52B	7	LDQ54	C (LVDS)*
R5	PL53A	7	LDQ54	T
R4	PL53B	7	LDQ54	C
GNDIO	GNDIO7	-		
M1	PL54A	7	LDQS54	T (LVDS)*
N2	PL54B	7	LDQ54	C (LVDS)*
R8	PL55A	7	LDQ54	T
T9	PL55B	7	LDQ54	C
P3	PL56A	7	LDQ54	T (LVDS)*
P2	PL56B	7	LDQ54	C (LVDS)*
N1	PL57A	7	PCLKT7_0/LDQ54	T
GNDIO	GNDIO7	-		
P1	PL57B	7	PCLKC7_0/LDQ54	C
T5	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
T4	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO2	-		
M27	PR47B	2	RDQ45	C (LVDS)*
M28	PR47A	2	RDQ45	T (LVDS)*
H30	PR46B	2	RDQ45	C
G30	PR46A	2	RDQ45	T
VCCIO	VCCIO2	2		
M25	PR45B	2	RDQ45	C (LVDS)*
M26	PR45A	2	RDQS45	T (LVDS)*
L30	PR44B	2	RDQ45	C
GNDIO	GNDIO2	-		
L29	PR44A	2	RDQ45	T
L28	PR43B	2	RDQ45	C (LVDS)*
L27	PR43A	2	RDQ45	T (LVDS)*
H29	PR42B	2	RDQ45	C
VCCIO	VCCIO2	2		
G29	PR42A	2	RDQ45	T
L22	PR41B	2	RDQ45	C (LVDS)*
M22	PR41A	2	RDQ45	T (LVDS)*
F30	PR40B	2		C
GNDIO	GNDIO2	-		
F29	PR40A	2		T
VCCIO	VCCIO2	2		
GNDIO	GNDIO2	-		
E30	PR34B	2	RDQ32	C (LVDS)*
E29	PR34A	2	RDQ32	T (LVDS)*
-	-	-		
L25	PR33B	2	RDQ32	C
L26	PR33A	2	RDQ32	T
VCCIO	VCCIO2	2		
H28	PR32B	2	RDQ32	C (LVDS)*
J28	PR32A	2	RDQS32	T (LVDS)*
G28	PR31B	2	RDQ32	C
GNDIO	GNDIO2	-		
G27	PR31A	2	RDQ32	T
L24	PR30B	2	RDQ32	C (LVDS)*
L23	PR30A	2	RDQ32	T (LVDS)*
D30	PR29B	2	RDQ32	C
VCCIO	VCCIO2	2		
D29	PR29A	2	RDQ32	T
K24	PR28B	2	RDQ32	C (LVDS)*
K25	PR28A	2	RDQ32	T (LVDS)*
J27	PR26B	2	RDQ23	C
GNDIO	GNDIO2	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K26	PR26A	2	RDQ23	T
K23	PR25B	2	RDQ23	C (LVDS)*
K22	PR25A	2	RDQ23	T (LVDS)*
J22	PR24B	2	RDQ23	C
VCCIO	VCCIO2	2		
J23	PR24A	2	RDQ23	T
GNDIO	GNDIO2	-		
VCCIO	VCCIO2	2		
J26	PR17B	2	RDQ15	C (LVDS)*
H26	PR17A	2	RDQ15	T (LVDS)*
H27	PR16B	2	RDQ15	C
G26	PR16A	2	RDQ15	T
VCCIO	VCCIO2	2		
H23	PR15B	2	RDQ15	C (LVDS)*
H24	PR15A	2	RDQS15	T (LVDS)*
D28	PR14B	2	RDQ15	C
GNDIO	GNDIO2	-		
E28	PR14A	2	RDQ15	T
G24	PR13B	2	RDQ15	C (LVDS)*
H25	PR13A	2	RDQ15	T (LVDS)*
D27	PR12B	2	RUM0_SPLLC_FB_A/RDQ15	C
VCCIO	VCCIO2	2		
E27	PR12A	2	RUM0_SPLLT_FB_A/RDQ15	T
F26	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*
G25	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*
F24	PR9B	2	VREF2_2	C
-	-	-		
GNDIO	GNDIO2	-		
F25	PR9A	2	VREF1_2	T
VCCIO	VCCIO2	2		
G23	XRES	1		
C30	URC_SQ_VCCR0	12		
A29	URC_SQ_HDINP0	12		T
B30	URC_SQ_VCCIB0	12		
B29	URC_SQ_HDINN0	12		C
C27	URC_SQ_VCCTX0	12		
A26	URC_SQ_HDOUTP0	12		T
A27	URC_SQ_VCCOB0	12		
B26	URC_SQ_HDOUTN0	12		C
C26	URC_SQ_VCCTX1	12		
B25	URC_SQ_HDOUTN1	12		C
C25	URC_SQ_VCCOB1	12		
A25	URC_SQ_HDOUTP1	12		T

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M23	GND	-		
M8	GND	-		
N14	GND	-		
N15	GND	-		
N16	GND	-		
N17	GND	-		
N27	GND	-		
N4	GND	-		
P11	GND	-		
P13	GND	-		
P14	GND	-		
P15	GND	-		
P16	GND	-		
P17	GND	-		
P18	GND	-		
P20	GND	-		
R10	GND	-		
R11	GND	-		
R13	GND	-		
R14	GND	-		
R15	GND	-		
R16	GND	-		
R17	GND	-		
R18	GND	-		
R20	GND	-		
R21	GND	-		
R24	GND	-		
R7	GND	-		
T10	GND	-		
T11	GND	-		
T13	GND	-		
T14	GND	-		
T15	GND	-		
T16	GND	-		
T17	GND	-		
T18	GND	-		
T20	GND	-		
T21	GND	-		
T24	GND	-		
T7	GND	-		
U11	GND	-		
U13	GND	-		
U14	GND	-		

LatticeECP2 S-Series Devices, Lead-Free Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5TN144C	90	1.2V	-5	Lead-Free TQFP	144	Com	6
LFE2-6SE-6TN144C	90	1.2V	-6	Lead-Free TQFP	144	Com	6
LFE2-6SE-7TN144C	90	1.2V	-7	Lead-Free TQFP	144	Com	6
LFE2-6SE-5FN256C	190	1.2V	-5	Lead-Free fpBGA	256	Com	6
LFE2-6SE-6FN256C	190	1.2V	-6	Lead-Free fpBGA	256	Com	6
LFE2-6SE-7FN256C	190	1.2V	-7	Lead-Free fpBGA	256	Com	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5TN144C	93	1.2V	-5	Lead-Free TQFP	144	Com	12
LFE2-12SE-6TN144C	93	1.2V	-6	Lead-Free TQFP	144	Com	12
LFE2-12SE-7TN144C	93	1.2V	-7	Lead-Free TQFP	144	Com	12
LFE2-12SE-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	Com	12
LFE2-12SE-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	Com	12
LFE2-12SE-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	Com	12
LFE2-12SE-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	Com	12
LFE2-12SE-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	Com	12
LFE2-12SE-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	Com	12
LFE2-12SE-5FN484C	297	1.2V	-5	Lead-Free fpBGA	484	Com	12
LFE2-12SE-6FN484C	297	1.2V	-6	Lead-Free fpBGA	484	Com	12
LFE2-12SE-7FN484C	297	1.2V	-7	Lead-Free fpBGA	484	Com	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	Com	20
LFE2-20SE-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	Com	20
LFE2-20SE-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	Com	20
LFE2-20SE-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	Com	20
LFE2-20SE-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	Com	20
LFE2-20SE-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	Com	20
LFE2-20SE-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	Com	20
LFE2-20SE-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	Com	20
LFE2-20SE-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	Com	20
LFE2-20SE-5FN672C	402	1.2V	-5	Lead-Free fpBGA	672	Com	20
LFE2-20SE-6FN672C	402	1.2V	-6	Lead-Free fpBGA	672	Com	20
LFE2-20SE-7FN672C	402	1.2V	-7	Lead-Free fpBGA	672	Com	20